| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|----------|--------|--|---|---------------------|---------|------------------|
| L1 | 20395 | (tape adhesion adhesive) adj3 carrier | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/01 07:52 |
| L2 | 565374 | (die chip semiconductor dice ic (integrated adj circuit)) with (multi multiple plurality stack stacking stacked mount mounted mounting) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/01 07:55 |
| L3 | 2168 | 1 with 2 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/01 07:55 |
| L4 | 1362 | 3 same (packaging package packaged) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/01 07:56 |
| L5 | 1 | "6060770".PN. | USPAT; USOCR | OR | OFF | 2005/05/01 08:09 |
| L6 | . 1 | "6265762".PN. | USPAT; USOCR | OR | OFF | 2005/05/01 08:09 |
| L7 | 1 | "6268644".PN. | USPAT; USOCR | OR | OFF | 2005/05/01 08:09 |
| L8 | 1 | "20020117742".PN. | US-PGPUB | OR | OFF | 2005/05/01 08:10 |
| L9 | 1 | "20010054751".PN. | US-PGPUB | OR | OFF | 2005/05/01 08:11 |
| L10 | 1 | "6476467".PN. | USPAT; USOCR | OR | OFF | 2005/05/01 08:11 |
| L11 | 1 | "6087722".PN. | USPAT; USOCR | OR | OFF | 2005/05/01 08:11 |
| L12 | 1 | "6080264".PN. | USPAT; USOCR | OR | OFF | 2005/05/01 08:11 |
| L13 | 1 | "6080264".PN. | USPAT; USOCR | OR | OFF | 2005/05/01 08:11 |
| L14 | 1 | "5949134".PN. | USPAT; USOCR | OR | OFF | 2005/05/01 08:11 |
| L15 | 1 | "5804874".PN. | USPAT; USOCR | OR | OFF | 2005/05/01 08:12 |
| L16 | 1 | "5508565".PN. | USPAT; USOCR | OR | OFF | 2005/05/01 08:12 |

| L17 | 1 | "5479051".PN. | USPAT; | OR | OFF | 2005/05/01 08:12 |
|-----|---|---------------|--------|----|-----|------------------|
| | | | USOCR | | | |